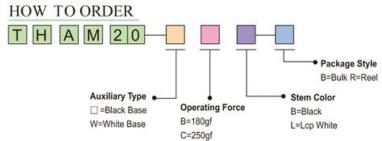
A SERIES





2.0x4.0 Dust-proof Miniature Type Tact Switch





Features

- Improve mounting density of components on PC board.
 Reflow solderable
- Contacts are completely sealed, enhancing reliability
- Packaged with a 12mm wide embossed taping.

Applications

- For operating various mobile devices
- For operating various devices that require high density mounting such as mobile phones, communication devices, compact electronic devices

Specification

Items Operating temperature range		Standard
Insulation resistance	100MW min. 100V DC	
Dielectric strength	250V AC for 1 min.	
Contact resistance	100mW max.	
Durability	Lifetime	A:B:E:50,000 Cycles min. C:30,000 Cycles
Mechanical performance	Operating force	B:180gf C:250gf
	Travel	0.15 ± 0.05mm

Diagram

No.	Dimensions	Circuit Diagram Pad Layout
• Th	1.5 1.5 1.5 1.6 1.6 1.70±0.1 1.70±0.1 1.5 1.5 1.5 1.5 1.5 1.5 1.5 1	1 0 2 3.8 0 0.6 2.7 0.6